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**SUPPLEMENTARY INFORMATION:**

| Incident identifier | Postponement identifier | Review board decision |
|---------------------|-------------------------|-----------------------|
| 2023-002-007 .....  | 2024-DOJ-02-0018a ..... | Approve.              |
| 2023-002-007 .....  | 2024-DOJ-02-0042 .....  | Approve with changes. |
| 2023-002-007 .....  | 2024-DOJ-02-0067a ..... | Approve.              |

*Authority:* Pub. L. 115-426, 132 Stat. 5489 (44 U.S.C. 2107).

Dated: August 4, 2026.

**Stephannie Oriabure,**  
*Chief of Staff.*

[FR Doc. 2026-16055 Filed 8-5-26; 8:45 am]

**BILLING CODE 6820-SY-P**

## DEPARTMENT OF COMMERCE

### Foreign-Trade Zones Board

[B-96-2026]

#### **Foreign-Trade Zone (FTZ) 18, Notification of Proposed Production Activity; Western Digital Technologies, Inc.; (Semiconductor Die); San Jose and Fremont California**

Western Digital Technologies, Inc. submitted a notification of proposed production activity to the FTZ Board (the Board) for its facilities in San Jose and Fremont, California within Subzone 18V. The notification conforming to the requirements of the Board's regulations (15 CFR 400.22) was received on July 29, 2026.

Pursuant to 15 CFR 400.14(b), FTZ production activity would be limited to the specific foreign-status material(s)/ component(s) and specific finished product(s) described in the submitted notification (summarized below) and subsequently authorized by the Board. The benefits that may stem from conducting production activity under FTZ procedures are explained in the background section of the Board's website—accessible via [www.trade.gov/ftz](http://www.trade.gov/ftz).

The proposed finished product is Die for Hard Disk Drive Head (duty-free).

The proposed foreign-status materials/components include: Single or multiple metal alloy sputtering targets containing at least one of the following metals: Ru, Al, Cr, Co, Ir, B, Fe, Ni, Hf, Ti, Pt, Ag, Mg, Ta, Ge, Mn, Mo, Zr, W, Y, Pd, Nb, Au, Rh, Sm; Undercoated .55–1.55um Alumina Substrates; EMD Performance Materials Corp AZ 10XT (100CP) Photoresist; EMD Performance Materials Corp AZ 10XT (50cP) Photoresist; EMD Performance Materials

Corp AZ 10XT Photoresist (520cP) Photoresist; EMD Performance Materials Corp AZ 1529 Photoresist; EMD Performance Materials Corp AZ 50XT Photoresist; EMD Performance Materials Corp AZ 9220 Photoresist (50CPS) Photoresist; EMD Performance Materials Corp AZ 9260 PHOTOESIST (520 CPS) Photoresist; EMD Performance Materials Corp AZ 7905 MIF Photoresist; EMD Performance Materials Corp AZ nLOF 2035 Photoresist; EMD Performance Materials Corp AZ P4110 Photoresist; EMD Performance Materials Corp AZ P4330-RS Photoresist; Dupont AR 602-510 Photoresist; JSR Micro, Inc. JSR ARF AR1891JN-30 Photoresist; JSR Micro, Inc. JSR ARF ARX3001JN-15 Photoresist; JSR Micro Inc. JSR ARF ARX3001JN-9Photoresist; JSR Micro, Inc. JSR NFC900 Photoresist; Fujifilm Electronic Materials LLCGKR-4602PP Photoresist; Rohm and Haas Electronic Materials LLC Microposit LOL 1000 Lift Off Layer Adhesion Promoting (PR1); Rohm and Haas Electronic Materials LLC Microposit LOL 1100 Lift Off Layer Adhesion Promoting (PR1); Rohm and Haas Electronic Materials LLC Microposit LOL 2000 Lift Off Layer Adhesion Promoting (PR1); Dow Megaposit SPR 955CM-1.4Photoresist; Kayaku Advanced Materials PMGI XS2Adhesion Promoting (PR1); Shin-Etsu Chemical Co., Ltd. SAIL X311 Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I032-3.5 Photoresist; Shin-Etsu Chemical Co., Inc.SEPR-I036-4.0 Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I036N-0.8Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I036N-4.0 Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I036NE-4.0 Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I051-1.5 Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I051N-1.5 Photoresist; Shin-Etsu MicroSi, Inc. SEPR-I032N-1.5 Photoresist; Shin-Etsu Chemical Co., Ltd.SIHM-A940-38 Photoresist; Shin-Etsu Chemical Co., Ltd.SEPR-I302N-1.5 Photoresist; Shin-Etsu Chemical Co., Ltd.SIHM-A943-0.1 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR 9272M-6.0 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR 9272N-6.0 (N-Version) Photoresist; Shin-Etsu Chemical Co., Inc. SIPR 9361L2M-2.0 Photoresist;

Shin-Etsu Chemical Co., Ltd. SIPR 9361M-2.5 Photoresist; Shin-Etsu Chemical Co., Inc. SIPR 9684HM-2.5 Photoresist; Shin-Etsu Chemical Co., Inc. SIPR 9740M-1.0 Photoresist; Shin-Etsu Chemical Co., Inc. SIPR 9770M-3.0 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR-9361L2N-2.0 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR-9361N-2.5 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR-9684HN-2.5 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR-9740N-1.0 Photoresist; Shin-Etsu Chemical Co., Ltd. SIPR-9770N-3.0 Photoresist; Shin-Etsu Chemical Co., Inc. SIPR-PR-1Adhesion Promoting (PR1); Sumitomo Chemical Co., Ltd. SUMIRESIST® PFI-38 series Photoresist; Tokyo Ohka Kogyo Co., Ltd.TARF-P7052 EM Photoresist; Tokyo Ohka Kogyo Co., Ltd. pr Photoresist; Tokyo Ohka Kogyo Co., Ltd.TDUR-P5107 (5.6cP) Photoresist; Fujifilm Electronic Materials USA, Inc.TIS193IL-A01 Photoresist; Rohm and Haas Electronic Materials LLCUV210GS-0.3 Positive DUV Photoresist; Rohm and Haas Electronic Materials LLCUV210GS-0.4 Positive DUV Photoresist; Dupont AR 3 GSF-600 DUV Photoresist; Fujifilm Electronic Materials USA, Inc. Durimide 20-400APhotoresist; Fujifilm Electronic Materials USA, Inc. Durimide 20-500APhotoresist; Fujifilm Electronic Materials USA, Inc. Durimide 20-1200A Photoresist; and Shin-Etsu Chemical Co., Ltd MPHP (Microprime HP Primer) Organo-silicon Hexamethyldisilazane (duty rate ranges from duty-free to 5.3%).

The request indicates that certain materials/components are subject to duties under section 301 of the Trade Act of 1974 (section 301), depending on the country of origin. The applicable section 301 decision requires subject merchandise to be admitted to FTZs in privileged foreign status (19 CFR 146.41).

Public comment is invited from interested parties. Submissions shall be addressed to the Board's Executive Secretary and sent to: [ftz@trade.gov](mailto:ftz@trade.gov). The closing period for their receipt is September 15, 2026.

A copy of the notification will be available for public inspection in the “Online FTZ Information System” section of the Board’s website.

For further information, contact John Frye at [John.Frye@trade.gov](mailto:John.Frye@trade.gov).

Dated: July 31, 2026.

**Elizabeth Whiteman,**  
Executive Secretary.

[FR Doc. 2026–15937 Filed 8–5–26; 8:45 am]

BILLING CODE 3510–DS–P

## DEPARTMENT OF COMMERCE

### Foreign-Trade Zones Board

[B–97–2026]

#### **Foreign-Trade Zone (FTZ) 39, Notification of Proposed Production Activity; Abbott Laboratories; (Diagnostic Medical Devices); Irving, Texas**

Abbott Laboratories submitted a notification of proposed production activity to the FTZ Board (the Board) for its facility in Irving, Texas within FTZ 39. The notification conforming to the requirements of the Board’s regulations (15 CFR 400.22) was received on August 3, 2026.

Pursuant to 15 CFR 400.14(b), FTZ production activity would be limited to the specific foreign-status material(s)/ component(s) and specific finished product(s) described in the submitted notification (summarized below) and subsequently authorized by the Board. The benefits that may stem from conducting production activity under FTZ procedures are explained in the background section of the Board’s website—accessible via [www.trade.gov/ftz](http://www.trade.gov/ftz).

*The proposed finished products include:* plastic fitting kits for waste pump quick connects; plastic fitting kits for buffer dilution systems; plastic waste containers; stainless steel screws and washers; indicator assemblies, including LEDs, optical sensors, plastic housing, wire harness and connectors; aluminum alignment tools; aluminum chute loaders; cooler assemblies with pumps, including a heat exchanger, sensors, electric pump, housing, and tubing; barcode scanner kits, including scanner with cable and connectors; sample wash stations; linear guides; tensioner assemblies, including tensioning arm, pulleys, springs, and screws; liner actuator motor assemblies, including motor, driver, housing, brackets, wire harness and connectors; hoppers; sensor assemblies, including sensors, molded hosing brackets, cable harness, and connectors; home sensors; photo-

electric sensors and cables; cable assemblies with connectors; fluid flow level sensor with cable assemblies; fluid pressure sensor with cable assemblies; conductivity sensors; fluid variable sensors with cable assemblies; diagnostic instrument analyzers; aspirate probe support boom arms; barcode scanner kits, including scanner with cable and connectors; bracket assemblies including brackets with pin and retaining rings; carrier assemblies, including carrier arm, frame, brackets and screws; degasser installation kits, including plastic tubing and connectors; diagnostic instrument alignment tool; diagnostic instrument cable assemblies; diagnostic instrument chute loaders; diagnostic instrument timing pulleys; dilution assemblies for buffer mixing and dilution system, including pump, tubing and connectors; disk carousel movement and plastic process path for reaction vessel transport assemblies; diverter assemblies, including plastic dividers for sample load platforms; drawer assembly kits, including slides, support brackets, mounting clips, and screws; electronic motor module assemblies, including motor, driver board, cables and connectors; encoder boards; fluid regulators; guide assemblies, including carriage, bushing, and rollers; holder assemblies, including mounting plate, screws, and washers; immobilizers; key cap assemblies, molded plastic key cap and stem-fit posts; latch support kits, including latches and catches for door panels; lift mechanisms; might control mechanisms; lock kits, including lock, brackets, and screws; manifold assemblies, including manifold body, valves, and tubing; mechanical load transport assemblies, including carriage motor, base plate, guide rails, brackets, load sensors and screws; metal hopper assemblies for reaction vessels; monitor arm kits, including arm assembly with base, brackets, and clamps; mount assemblies, including mounting plate, screws, and washers; mount kits, including brackets and screws; optical sensor assemblies, including optical sensor, optical receiver, sensor housing, cables with connectors; picker arm assemblies, including arm structure, claw, linkage, motor, brackets, and screws; pinch arm assemblies, including arm structure, claw, linkage, motor, brackets, and screws; pinch nut kits, including slotted nuts, washers and screws; pipettor assemblies, including pipettor tips, tubing, pump mechanism, brackets, linkage and screws; plug kits, including a silicone cap cover; printed circuit board assemblies, including printed circuit board, processor, and

connectors; protective cover assemblies, including cover and fasteners; rail assemblies, including guide rails and screws; reagent loader nanocarrier; reservoir assemblies, including a basin, tubing and connectors; rotating assemblies, including plastic disk, gears and supports; sensor assemblies, including sensors, molded housing, brackets, cable harness, and connectors; sensor probes; spring mechanism assemblies, including springs, housing, carriages, and brackets; stat diverters; storage container assemblies, including container and brackets; structure assemblies, including metal support structures, slide rails and brackets; suspension travelers; tubing assemblies, including tubes and brackets; vacuum accumulator assemblies, including bottle with tubing and sensors; vacuum upgrade kits, including vacuum pump and tubing with connectors; vent assemblies, including metal vents, screws and brackets; vertical stops; wash station assemblies, including wash basin, spray nozzles, drain ports, and tubing; waste separators; and, fixture assemblies, including brackets and rods for casters (duty rate ranges from duty-free to 5.80%).

The proposed foreign-status materials/components include: accessory kits, for field service including screws, tubing, wire cables with connectors, wire clamps; actuators; adaptors; adhesive backing for baffle mounting; adhesive bottle labels; adhesive label rolls; adhesive label sheets; air cylinder assemblies, including metal diverter plates and screws; alignment bearing assemblies, including plastic support disk, and brackets; alignment fixtures; aluminum adapter bodies; aluminum adapters; aluminum adapters brackets; aluminum alert arms; aluminum alert brackets; aluminum alignment tools; aluminum antenna brackets; aluminum arm loaders; aluminum axis brackets; aluminum base plate assemblies, including support structure and screws; aluminum bases; aluminum blocks; aluminum board covers; aluminum bolts; aluminum bracket mounts; aluminum calibration tools; aluminum caps; aluminum card cage; aluminum chain guides; aluminum clamp bodies; aluminum clamps; aluminum collars; aluminum connectors; aluminum dowels; aluminum frames; aluminum grabbers; aluminum inserts; aluminum latches; aluminum leadscrews; aluminum loader adapters; aluminum lock bodies; aluminum locks; aluminum mounting plates; aluminum mounts; aluminum pins; aluminum sleeves; aluminum strips; aluminum structures;